

# CompactPCI Dual Hot Swap Controller

## FEATURES

- Allows Safe Board Insertion and Removal from a Live, CompactPCI™ Bus
- Controls 3.3V and/or 5V Supplies
- Programmable Foldback Current Limit During Power-Up
- Dual Level Circuit Breakers Protect Supplies from Overcurrent and Short-Circuit Faults
- LOCAL\_PCI\_RST# Logic On-Chip
- PRECHARGE Output Biases I/O Pins During Card Insertion and Extraction
- User Programmable Supply Voltage Power-Up Rate
- 15V High Side Drive for External N-Channel MOSFETS
- PWRGD, RESETOUT and FAULT Outputs

## APPLICATIONS

- CompactPCI Bus Removable Boards

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Hot Swap is a trademark of Linear Technology Corporation.  
CompactPCI is a trademark of the PCI Industrial Computer Manufacturers Group.

## DESCRIPTION

The LTC®1646 is a Hot Swap™ controller that allows a board to be safely inserted and removed from a live CompactPCI bus slot. Two external N-Channel transistors control the 3.3V and 5V supplies. The supplies can be ramped-up in current limit or a programmable rate. Electronic circuit breakers protect both supplies against overcurrent fault conditions. The PWRGD output indicates when all of the supply voltages are within tolerance. The OFF/ON pin is used to cycle the board power or reset the circuit breaker. The PRECHARGE output can be used to bias the bus I/O pins during card insertion and extraction. PCI\_RST# is logically combined on-chip with HEALTHY# in order to generate LOCAL\_PCI\_RST# which can be used to reset the CPCI card logic if either of the supply voltages is not within tolerance.

The LTC1646 is available in the 16-pin narrow SSOP package.

## TYPICAL APPLICATION

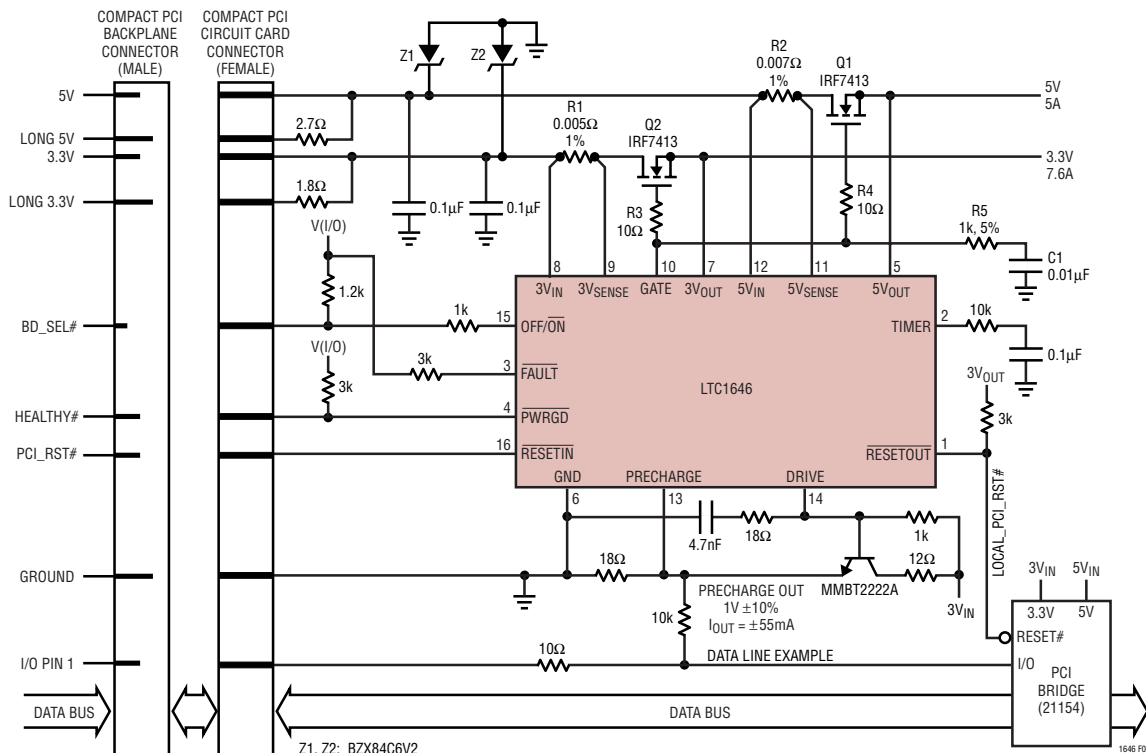


Figure 1

sn1646 1646fs

## ABSOLUTE MAXIMUM RATINGS

(Note 1)

Supply Voltages:  $5V_{IN}$ ,  $3V_{IN}$  ..... 10VInput Voltages: (Pins 15, 16) .....  $-0.3V$  to  $(5V_{IN} + 0.3V)$ Output Voltages: (Pins 1, 3, 4) ...  $-0.3V$  to  $(5V_{IN} + 0.3V)$ 

Analog Voltages and Currents:

(Pins 9, 11) .....  $-0.3V$  to  $5V_{IN}$ (Pins 2, 5, 7, 13, 14) .....  $-0.3V$  to  $(5V_{IN} + 0.3V)$ (Pin 10) .....  $\pm 20mA$ 

Operating Temperature Range:

LTC1646C .....  $0^{\circ}C$  to  $70^{\circ}C$ LTC1646I .....  $-40^{\circ}C$  to  $85^{\circ}C$ Storage Temperature Range .....  $-65^{\circ}C$  to  $150^{\circ}C$ Lead Temperature (Soldering, 10 sec) .....  $300^{\circ}C$ 

## PACKAGE/ORDER INFORMATION

TOP VIEW		ORDER PART NUMBER
RESETOUT 1	16 RESETIN	LTC1646CGN LTC1646IGN
TIMER 2	15 OFF/ON	
FAULT 3	14 DRIVE	GN PART MARKING
PWRGD 4	13 PRECHARGE	
5VOUT 5	12 5V <sub>IN</sub>	1646 1646I
GND 6	11 5V <sub>SENSE</sub>	
3VOUT 7	10 GATE	
3VIN 8	9 3V <sub>SENSE</sub>	
GN PACKAGE 16-LEAD PLASTIC SSOP T <sub>JMAX</sub> = 125°C, $\theta_{JA}$ = 135°C/W		

Consult LTC Marketing for parts specified with wider operating temperature ranges.

## ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^{\circ}C$ .  $V_{5VIN} = 5V$  and  $V_{3VIN} = 3.3V$  unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
$I_{DD}$	$V_{5VIN}$ Supply Current	OFF/ON = 0V	●		1.5	4	mA
$V_{LKO}$	Undervoltage Lockout	$5V_{IN}$ $3V_{IN}$	● ●	2.3 2.3	2.50 2.55	2.7 2.7	V V
$V_{FB}$	Foldback Current Limit Voltage	$V_{FB} = (V_{5VIN} - V_{5VSENSE})$ , $V_{5VOUT} = 0V$ , $TIMER = 0V$ $V_{FB} = (V_{5VIN} - V_{5VSENSE})$ , $V_{5VOUT} = 4V$ , $TIMER = 0V$ $V_{FB} = (V_{3VIN} - V_{3VSENSE})$ , $V_{3VOUT} = 0V$ , $TIMER = 0V$ $V_{FB} = (V_{3VIN} - V_{3VSENSE})$ , $V_{3VOUT} = 2V$ , $TIMER = 0V$	● ● ● ●	15 50 15 50	20 55 20 55	30 65 30 65	mV mV mV mV
$V_{CB}$	Circuit Breaker Trip Voltage	$V_{CB} = (V_{5VIN} - V_{5VSENSE})$ , $V_{5VOUT} = 5V$ , $TIMER$ Open $V_{CB} = (V_{3VIN} - V_{3VSENSE})$ , $V_{3VOUT} = 3.3V$ , $TIMER$ Open	● ●	50 50	56 56	65 65	mV mV
$t_{OC}$	Overcurrent Fault Response Time	$(V_{5VIN} - V_{5VSENSE}) = 100mV$ , $TIMER$ Open $(V_{3VIN} - V_{3VSENSE}) = 100mV$ , $TIMER$ Open	● ●	10 10	21 21	30 30	$\mu s$ $\mu s$
$t_{SS}$	Short-Circuit Fault Response Time	$(V_{5VIN} - V_{5VSENSE}) = 200mV$ , $TIMER$ Open $(V_{3VIN} - V_{3VSENSE}) = 200mV$ , $TIMER$ Open	● ●		0.145 0.145	1 1	$\mu s$ $\mu s$
$I_{CP}$	GATE Pin Output Current	OFF/ON = 0V, $V_{GATE} = 0V$ , $TIMER = 0V$ OFF/ON = 5V, $V_{GATE} = 5V$ , $TIMER = 0V$ OFF/ON = 0V, $V_{GATE} = 5V$ , $FAULT = 0V$ , $TIMER$ Open	● ● ●	-18 80 4	-13 200 7	-8 300 12	$\mu A$ $\mu A$ mA
$V_{GATE}$	External Gate Voltage (GATE to GND)	OFF/ON = 0V, $I_{GATE} = -1\mu A$ OFF/ON = 0V, $V_{5VIN} = 3.3V$ , $I_{GATE} = -1\mu A$	● ●	12 11	15 13	16 15	V V
$V_{TH}$	Power Good Threshold Voltage	$3V_{OUT}$ $5V_{OUT}$	● ●	2.8 4.5	2.9 4.65	3.0 4.75	V V
$V_{3VONLY}$	No 5V Input Mode Window Voltage	$V_{3VONLY} =  V_{5VIN} - V_{3VIN} $ , $V_{5VOUT} = V_{3VOUT} = 3.3V$	●	50	120	200	mV
$V_{IL}$	Input Low Voltage	OFF/ON, RESETIN, FAULT	●			0.8	V
$V_{IH}$	Input High Voltage	OFF/ON, RESETIN, FAULT	●	2			V
$V_{TIMER}$	TIMER Threshold Voltage	$V_{TIMER}$ , FAULT = 0V	●	1.15	1.25	1.35	V

## ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ .  $V_{5VIN} = 5\text{V}$  and  $V_{3VIN} = 3.3\text{V}$  unless otherwise noted.

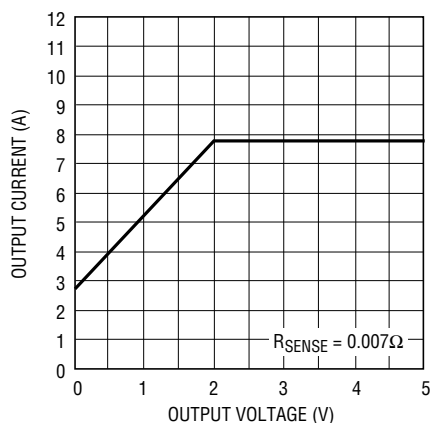
SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
I <sub>IN</sub>	OFF/ $\overline{\text{ON}}$ Input Current	OFF/ $\overline{\text{ON}}$ = 5V	●		±0.08	±10	μA
		OFF/ $\overline{\text{ON}}$ = 0V	●		±0.08	±10	μA
	$\overline{\text{RESETIN}}$ Input Current	$\overline{\text{RESETIN}}$ = 5V	●		±0.08	±10	μA
		$\overline{\text{RESETIN}}$ = 0V	●		±0.08	±10	μA
	5V <sub>SENSE</sub> Input Current	5V <sub>SENSE</sub> = 5V, 5V <sub>OUT</sub> = 0V	●		66	100	μA
	3V <sub>SENSE</sub> Input Current	3V <sub>SENSE</sub> = 3.3V, 3V <sub>OUT</sub> = 0V	●		66	100	μA
	3V <sub>IN</sub> Input Current	3V <sub>IN</sub> = 3.3V	●		460	1000	μA
	5V <sub>OUT</sub> Input Current	5V <sub>OUT</sub> = 5V, OFF/ $\overline{\text{ON}}$ = 0V	●		0.9	1.5	mA
	3V <sub>OUT</sub> Input Current	3V <sub>OUT</sub> = 3.3V, OFF/ $\overline{\text{ON}}$ = 0V	●		0.9	1.5	mA
I <sub>TIMER</sub>	TIMER Pin Current	OFF/ $\overline{\text{ON}}$ = 0V, V <sub>TIMER</sub> = 0V	●	−7	−5	−3	μA
		OFF/ $\overline{\text{ON}}$ = 5V, V <sub>TIMER</sub> = 5V			6.6		mA
R <sub>DIS</sub>	5V <sub>OUT</sub> Discharge Impedance	OFF/ $\overline{\text{ON}}$ = 5V	●		120	220	Ω
	3V <sub>OUT</sub> Discharge Impedance	OFF/ $\overline{\text{ON}}$ = 5V	●		120	220	Ω
V <sub>OL</sub>	Output Low Voltage	$\overline{\text{FAULT}}$ , $\overline{\text{PWRGD}}$ , $\overline{\text{RESETOUT}}$ , I = 2mA	●		0.25	0.4	V
V <sub>PXG</sub>	PRECHARGE Reference Voltage	V <sub>PRECHARGE</sub> , V <sub>5VIN</sub> = 5V and 3.3V	●	0.90	1.00	1.10	V

**Note 1:** Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

**Note 2:** All currents into device pins are positive; all currents out of device pins are negative. All voltages are referenced to ground unless otherwise specified.

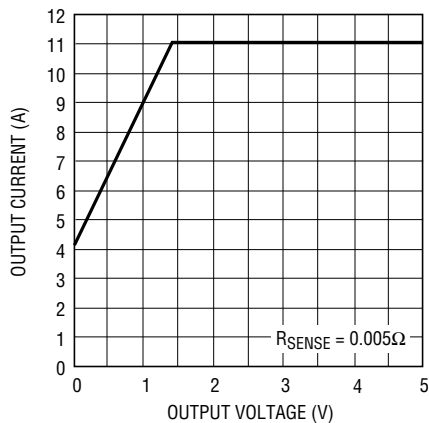
## TYPICAL PERFORMANCE CHARACTERISTICS

5V Current Foldback Profile



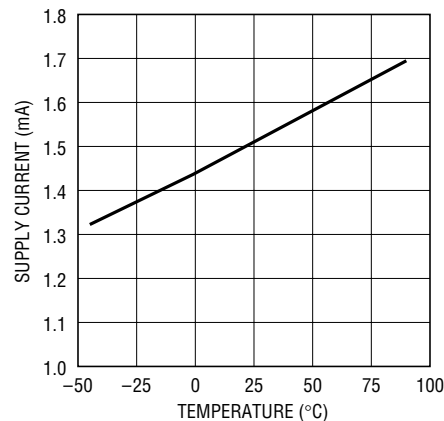
1646 G01

3.3V Current Foldback Profile



1646 G02

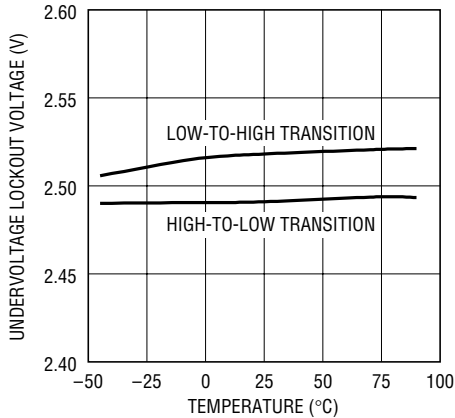
5V<sub>IN</sub> Supply Current vs Temperature



1646 G03

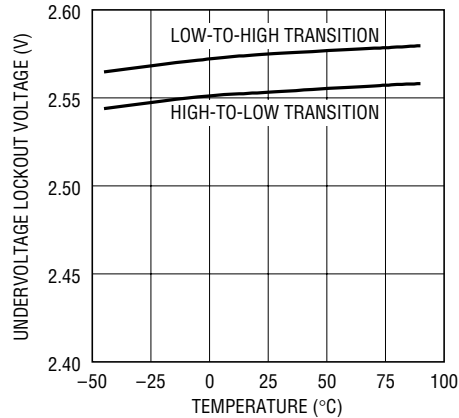
## TYPICAL PERFORMANCE CHARACTERISTICS

**5V<sub>IN</sub> Undervoltage Lockout Voltage vs Temperature**



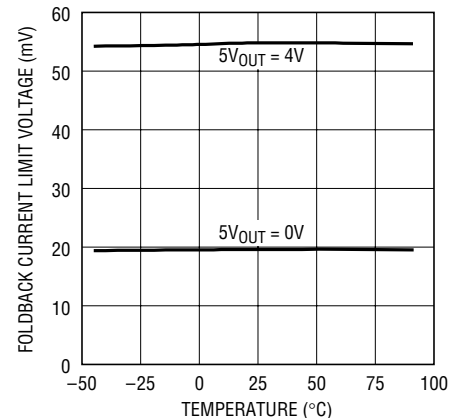
1646 G04

**3V<sub>IN</sub> Undervoltage Lockout Voltage vs Temperature**



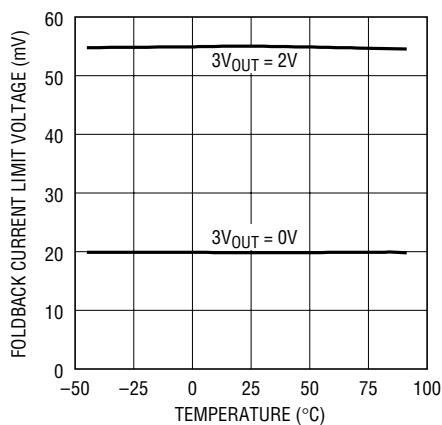
1646 G05

**5V<sub>IN</sub> Foldback Current Limit Voltage vs Temperature**



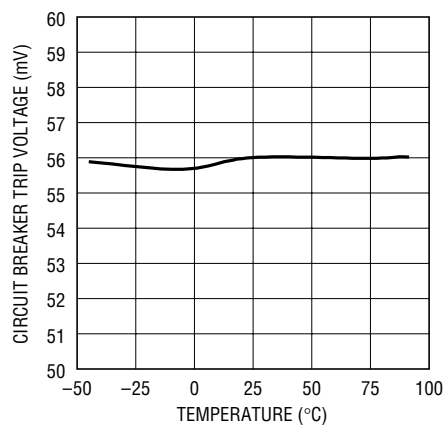
1646 G06

**3V<sub>IN</sub> Foldback Current Limit Voltage vs Temperature**



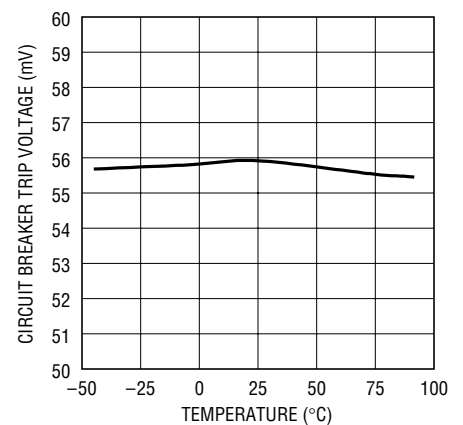
1646 G07

**5V<sub>IN</sub> Circuit Breaker Trip Voltage vs Temperature**



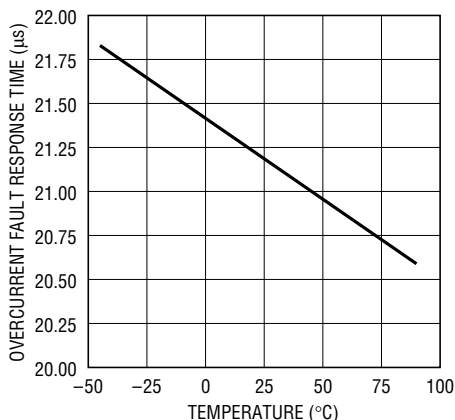
1646 G08

**3V<sub>IN</sub> Circuit Breaker Trip Voltage vs Temperature**



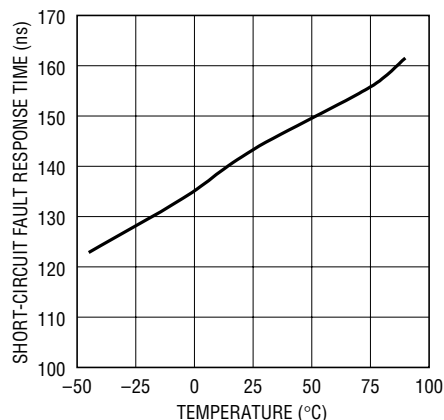
1646 G09

**5V<sub>IN</sub>/3V<sub>IN</sub> Overcurrent Fault Response Time vs Temperature**



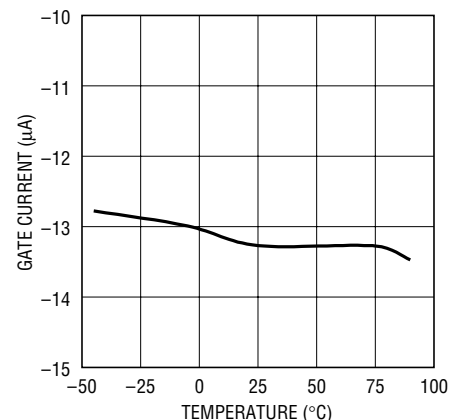
1646 G10

**5V<sub>IN</sub>/3V<sub>IN</sub> Short-Circuit Fault Response Time vs Temperature**



1646 G11

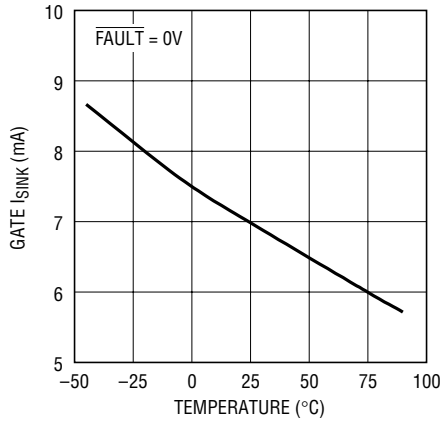
**Gate Current vs Temperature**



1646 G12

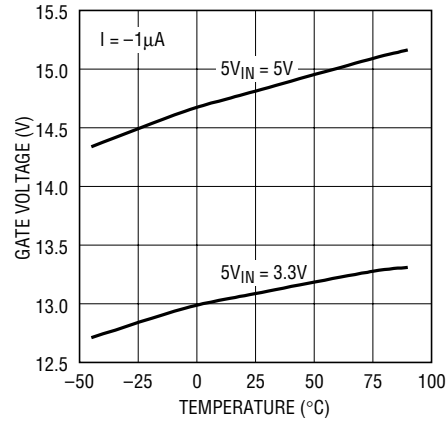
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## TYPICAL PERFORMANCE CHARACTERISTICS

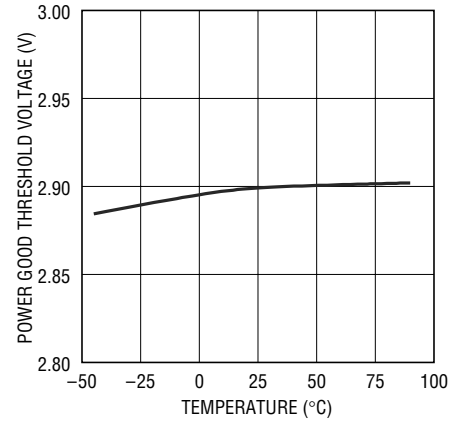
Gate  $I_{SINK}$  vs Temperature

1646 G13

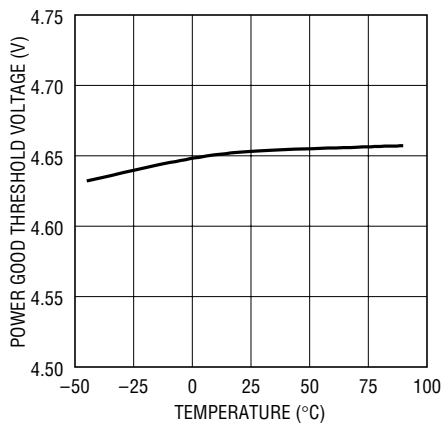
Gate Voltage vs Temperature



1646 G14

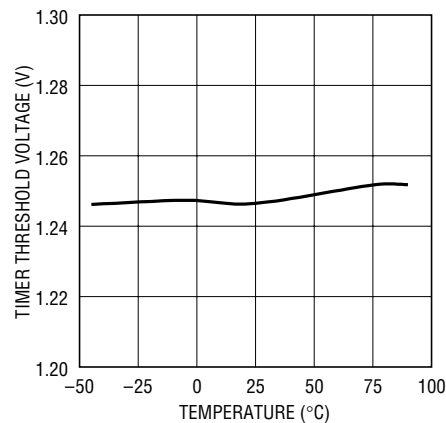
Power Good Threshold Voltage vs Temperature ( $3V_{OUT}$ )

1646 G15

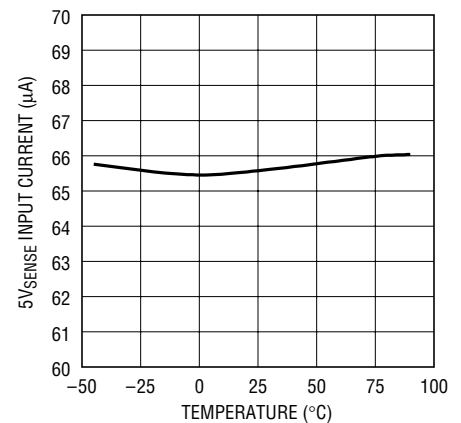
Power Good Threshold Voltage vs Temperature ( $5V_{OUT}$ )

1646 G16

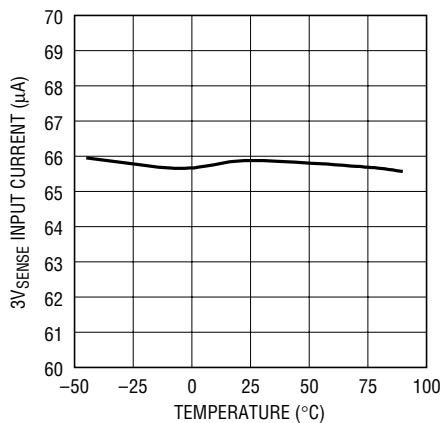
Timer Threshold Voltage vs Temperature



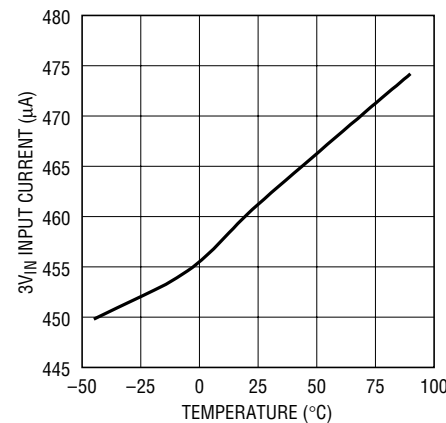
1646 G17

 $5V_{SENSE}$  Input Current vs Temperature

1646 G18

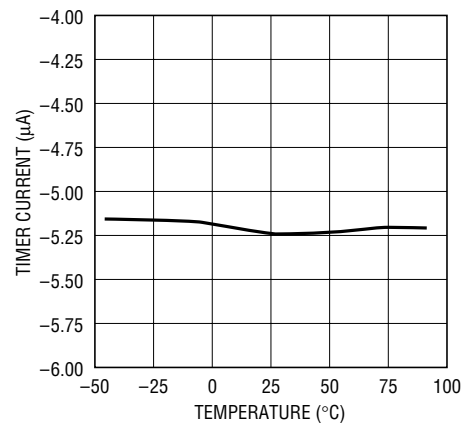
 $3V_{SENSE}$  Input Current vs Temperature

1646 G19

 $3V_{IN}$  Input Current vs Temperature

1646 G20

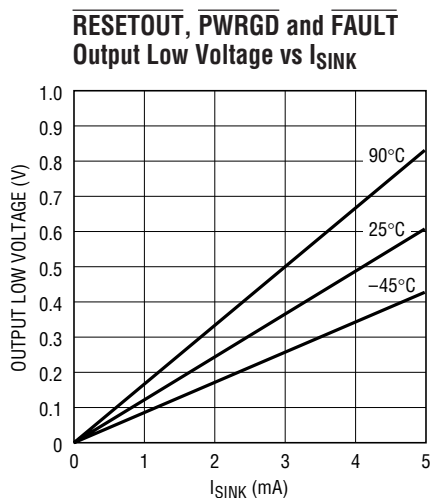
Timer Current vs Temperature



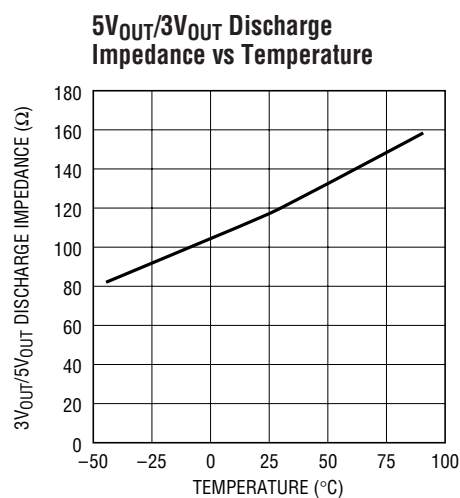
1646 G21

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## TYPICAL PERFORMANCE CHARACTERISTICS



1646 G22



1646 G23

## PIN FUNCTIONS

**RESETOUT (Pin 1):** Open Drain Digital Output. Connect the CPCI LOCAL\_PCI\_RST# signal to the RESETOUT pin. RESETOUT is the logical combination of RESETIN and PWRGD (see Table 4).

**TIMER (Pin 2):** Current Fault Inhibit Timing Input. Connect a capacitor from TIMER to GND. With the chip turned off, the TIMER pin is internally held at GND. When the chip is turned on, a 5μA pull-up current source is connected to TIMER. Current limit and voltage compliance faults will be ignored until the voltage at the TIMER pin is greater than 1.25V.

**FAULT (Pin 3):** Open Drain Digital I/O. FAULT is pulled low when a current limit fault is detected. Faults are ignored while the voltage at the TIMER pin is less than 1.25V. Once the TIMER cycle is complete, FAULT will pull low and the chip will latch off in the event of an overcurrent fault. The chip will remain latched in the off state until the OFF/ON pin is cycled high then low or the power is cycled.

Forcing the FAULT pin low with an external pull-down will cause the chip to be latched into the off state after a 21μs deglitching time.

**PWRGD (Pin 4):** Open Drain Power Good Digital Output. Connect the CPCI HEALTHY# signal to the PWRGD pin. PWRGD remains low while  $V_{3V_{OUT}} \geq 2.9V$  and  $V_{5V_{OUT}} \geq 4.65V$ . When either of the supplies falls below its power good threshold voltage, PWRGD will go high after a 50μs deglitching time.

**5V<sub>OUT</sub> (Pin 5):** 5V Output Sense. The PWRGD pin will not pull low until the 5V<sub>OUT</sub> pin voltage exceeds 4.65V. If no 5V input supply is available, tie the 5V<sub>OUT</sub> pin to the 3V<sub>OUT</sub> pin in order to disable the 5V<sub>OUT</sub> power good function.

**GND (Pin 6):** Chip Ground

**3V<sub>OUT</sub> (Pin 7):** 3.3V Output Sense. The PWRGD pin will not pull low until the 3V<sub>OUT</sub> pin voltage exceeds 2.90V. If no 3.3V input supply is available, tie the 3V<sub>OUT</sub> pin to the 5V<sub>OUT</sub> pin.

**3V<sub>IN</sub> (Pin 8):** 3.3V Supply Sense Input. An undervoltage lockout circuit prevents the switches from turning on when the voltage at the 3V<sub>IN</sub> pin is less than 2.5V. If no 3.3V input supply is available, connect a diode between 5V<sub>IN</sub> and 3V<sub>IN</sub> (tie anode to 5V<sub>IN</sub> and cathode to 3V<sub>IN</sub>). See Figure 11.

## PIN FUNCTIONS

**3V<sub>SENSE</sub> (Pin 9):** 3.3V Current Limit Set. With a sense resistor placed in the supply path between 3V<sub>IN</sub> and 3V<sub>SENSE</sub>, the GATE pin voltage will be adjusted to maintain a constant voltage across the sense resistor and a constant current through the switch while the TIMER pin voltage is less than 1.25V. A foldback feature makes the current limit decrease as the voltage at the 3V<sub>OUT</sub> pin approaches GND.

When the TIMER pin voltage exceeds 1.25V, the circuit breaker function is enabled. If the voltage across the sense resistor exceeds 56mV, the circuit breaker is tripped after a 21μs time delay. In the event the sense resistor voltage exceeds 150mV, the circuit breaker trips immediately and the chip latches off. To disable the 3.3V current limit, 3V<sub>SENSE</sub> and 3V<sub>IN</sub> can be shorted together.

**GATE (Pin 10):** High Side Gate Drive for the External 3.3V and 5V N-Channel pass transistors. Requires an external series RC network for the current limit loop compensation and setting the minimum ramp-up rate. During power-up, the slope of the voltage rise at the GATE is set by the 13μA current source connected to the internal charge pump and the external capacitor connected to GND or by the 3.3V or 5V current limit and the bulk capacitance on the 3V<sub>OUT</sub> or 5V<sub>OUT</sub> supply lines. During power-down, the slope of the ramp down voltage is set by the 200μA current source connected to GND and the external GATE capacitor.

The voltage at the GATE pin will be modulated to maintain a constant current when either the 3V or 5V supplies go into current limit while the TIMER pin voltage is less than 1.25V. If a current fault occurs after the TIMER pin voltage exceeds 1.25V, the GATE pin is immediately pulled to GND.

**5V<sub>SENSE</sub> (Pin 11):** 5V Current Limit Set. With a sense resistor placed in the supply path between 5V<sub>IN</sub> and 5V<sub>SENSE</sub>, the GATE pin voltage will be adjusted to maintain a constant voltage across the sense resistor and a constant current through the switch while the TIMER pin voltage is less than 1.25V. A foldback feature makes the current limit decrease as the voltage at the 5V<sub>OUT</sub> pin approaches GND.

When the TIMER pin voltage is greater than 1.25V, the circuit breaker function is enabled. If the voltage across the sense resistor exceeds 56mV but is less than 150mV, the circuit breaker is tripped after a 21μs time delay. In the event the sense resistor voltage exceeds 150mV, the circuit breaker trips immediately and the chip latches off. To disable the 5V current limit, short 5V<sub>SENSE</sub> and 5V<sub>IN</sub> together.

**5V<sub>IN</sub> (Pin 12):** 5V Supply Sense Input. An undervoltage lockout circuit prevents the GATE pin voltage from ramping up when the voltage at the 5V<sub>IN</sub> pin is less than 2.5V. If no 5V input supply is available, tie the 5V<sub>IN</sub> pin to the 3V<sub>IN</sub> pin.

**PRECHARGE (Pin 13):** Precharge Monitor Input. An on-chip error amplifier with a 1V reference servos the DRIVE pin voltage to keep the precharge node at 1V. If the precharge function is not being used, tie the PRECHARGE pin to GND.

**DRIVE (Pin 14):** Precharge Base Drive Output. Provides base drive for an external NPN emitter-follower which in turn biases the PRECHARGE node. If the precharge function is not being used, allow the DRIVE pin to float.

**OFF/ $\overline{\text{ON}}$  (Pin 15):** Digital Input. Connect the CPCI BD\_SEL# signal to the OFF/ $\overline{\text{ON}}$  pin. When the OFF/ $\overline{\text{ON}}$  pin is pulled low, the GATE pin is pulled high by a 13μA current source. When the OFF/ $\overline{\text{ON}}$  pin is pulled high the GATE pin will be pulled to ground by a 200μA current source.

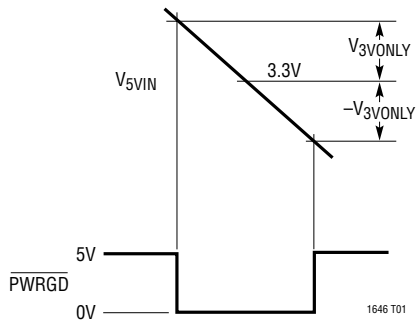
The OFF/ $\overline{\text{ON}}$  pin is also used to reset the electronic circuit breaker. If the OFF/ $\overline{\text{ON}}$  pin is cycled high and low following the trip of the circuit breaker, the circuit breaker is reset, and a normal power-up sequence will occur.

**RESETIN (Pin 16):** Digital Input. Connect the CPCI PCI\_RST# signal to the RESETIN pin. Pulling RESETIN low will cause the RESETOUT pin to pull low.

TEST DIAGRAM

V<sub>3VONLY</sub> No 5V Input Mode Window Voltage

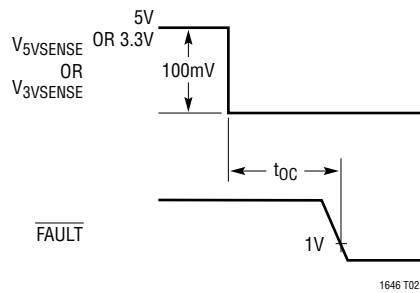
$V_{3VONLY} = |5V_{IN} - 3V_{IN}|$   $5V_{OUT} = 3V_{OUT} = 3.3V$ ,  $3V_{IN} = 3.3V$



TIMING DIAGRAMS

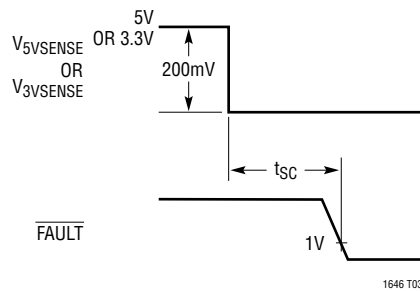
t<sub>OC</sub> Overcurrent Fault Detect

FALL TIME ≤ 1μs, 5V<sub>IN</sub> = 5V, 3V<sub>IN</sub> = 3.3V



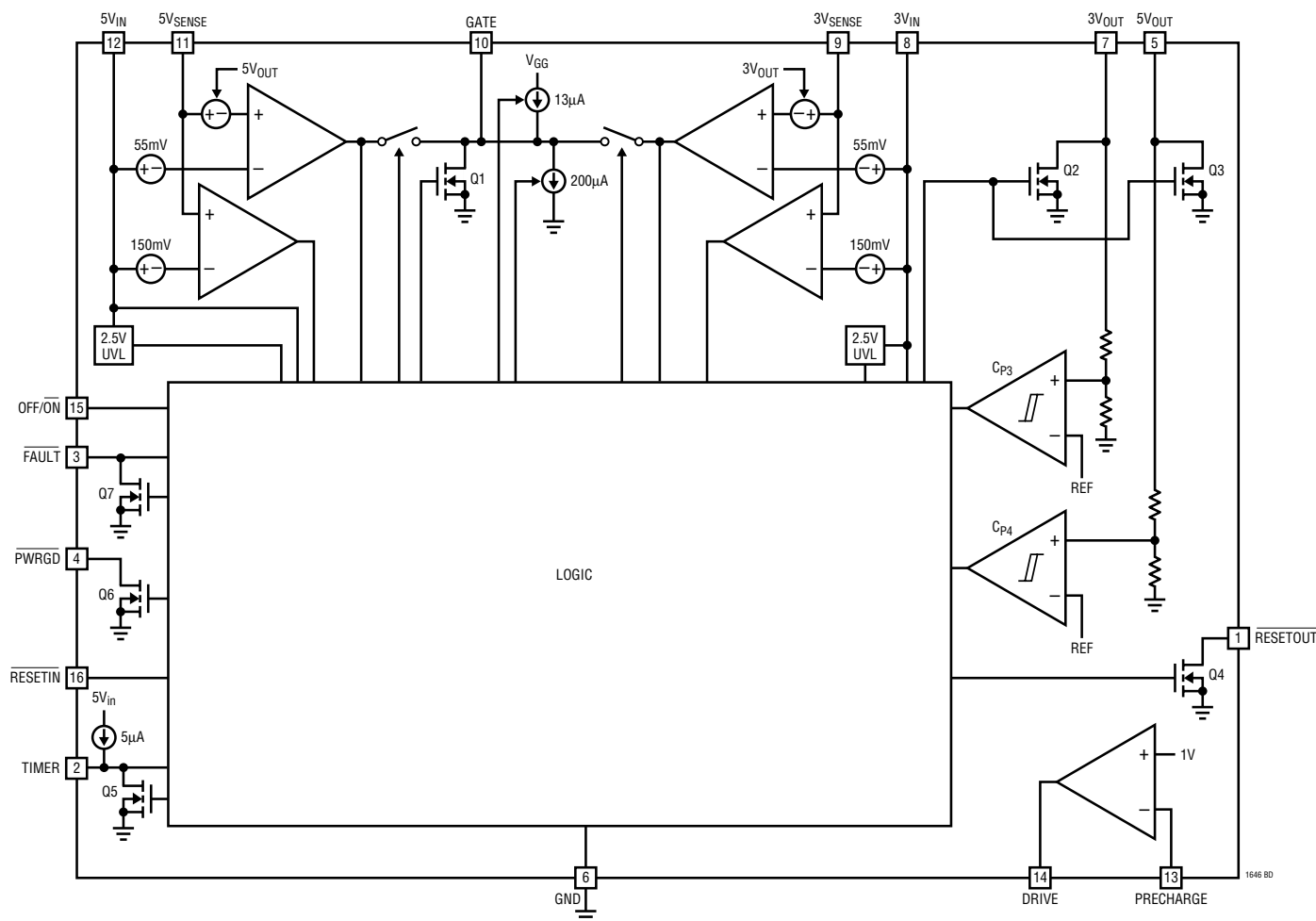
t<sub>SC</sub> Short-Circuit Fault Detect

FALL TIME ≤ 30ns, 5V<sub>IN</sub> = 5V, 3V<sub>IN</sub> = 3.3V





## BLOCK DIAGRAM



## APPLICATIONS INFORMATION

### Hot Circuit Insertion

When a circuit board is inserted into a live CompactPCI (CPCI) slot, the supply bypass capacitors on the board can draw huge supply transient currents from the CPCI power bus as they charge up. The transient currents can cause glitches on the power bus, causing other boards in the system to reset.

The LTC1646 is designed to turn a board's supply voltages on and off in a controlled manner, allowing the board to be safely inserted or removed from a live CPCI slot without glitching the system power supplies. The chip also protects the supplies from shorts, precharges the bus I/O pins during insertion and extraction and monitors the supply voltages.

The LTC1646 is specifically designed for CPCI applications where the chip resides on the plug-in board.

### LTC1646 Feature Summary

1. Allows safe board insertion and removal from a CPCI backplane.
2. Controls 5V and 3.3V CPCI supplies.
3. Current limit during power-up: the supplies are allowed to power up in current limit. This allows the chip to power up boards with widely varying capacitive loads without tripping the circuit breaker. The maximum allowable power-up time is programmable using the TIMER pin and an external capacitor.

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4. Programmable foldback current limit: a programmable analog current limit with a value that depends on the output voltage. If the output is shorted to ground, the current limit drops to keep power dissipation and supply glitches to a minimum.
5. Dual-level, programmable 5V and 3.3V circuit breakers: this feature is enabled when the **TIMER** pin voltage exceeds 1.25V. If either supply exceeds current limit for more than 21μs, the circuit breaker will trip, the supplies will be turned off, and the **FAULT** pin is pulled low. In the event that either supply exceeds three times the set current limit, all supplies will be turned off and the **FAULT** pin is pulled low without delay.
6. 15V high side drive for external 3.3V and 5V N-channel MOSFETs.
7. **PWRGD** output: monitors the voltage status of the supply voltages.
8. **PCI\_RST#** combined on-chip with **HEALTHY#** to create **LOCAL\_PCI\_RST#** output. If **HEALTHY#** deasserts, **LOCAL\_PCI\_RST#** is asserted independent of **PCI\_RST#**.
9. Precharge output: on-chip reference and amplifier provide 1V for biasing bus I/O connector pins during CPCI card insertion and extraction.
10. Space saving 16-pin SSOP package.

### PCI Power Requirements

CPCI systems may require up to four power rails: 5V, 3.3V, 12V and -12V. The LTC1646 is designed for CPCI applications which only use the 5V and/or 3.3V supplies. The tolerance of the supplies as measured at the components on the plug-in card is summarized in Table 1.

**Table 1. PCI Power Supply Requirements**

SUPPLY	TOLERANCE	CAPACITIVE LOAD
5V	5V ±5%	<3000μF
3.3V	3.3V ±0.3V	<3000μF

### Power-Up Sequence

The LTC1646 is specifically designed for hot swapping CPCI boards. The typical application is shown in Figure 1.

The main 3.3V and 5V inputs to the LTC1646 come from the medium length power pins. The long 3.3V, 5V connector pins are shorted to the medium length 5V and 3.3V connector pins on the CPCI plug-in card and provide early power for the LTC1646's precharge circuitry, the V(I/O) pull-up resistors and the PCI bridge chip. The **BD\_SEL#** signal is connected to the **OFF/ON** pin while the **PWRGD** pin is connected to the **HEALTHY#** signal. The **HEALTHY#** signal is combined with the **PCI\_RST#** signal on-chip to generate the **LOCAL\_PCI\_RST#** signal which is available at the **RESETOUT** pin.

The power supplies are controlled by placing external N-channel pass transistors in the 3.3V and 5V power paths.

Resistors R1 and R2 provide current fault detection and R5 and C1 provide current control loop compensation. Resistors R3 and R4 prevent high frequency oscillations in Q1 and Q2.

When the CPCI card is inserted, the long 5V and 3.3V connector pins and GND pins make contact first. The LTC1646's precharge circuit biases the bus I/O pins to 1V during this stage of the insertion (Figure 2). The 5V and 3.3V medium length pins make contact during the next stage of insertion, but the slot power is disabled as long as the **OFF/ON** pin is pulled high by the 1.2k pull-up resistor to V(I/O). During the final stage of board insertion, the **BD\_SEL#** short connector pin makes contact and the **OFF/ON** pin can be pulled low. This enables the pass transistors to turn on and a 5μA current source is connected to the **TIMER** pin.

The current in each pass transistor increases until it reaches the current limit for each supply. The 5V and 3.3V supplies are then allowed to power up based on one of the following power-up rates:

$$\frac{dV}{dt} = \frac{13\mu A}{C1}, \text{ or } = \frac{I_{LIMIT(5V)}}{C_{LOAD(5VOUT)}}, \text{ or } = \frac{I_{LIMIT(3V)}}{C_{LOAD(3VOUT)}}$$

whichever is slower.

Current limit faults are ignored while the **TIMER** pin voltage is ramping up and is less than 1.25V. Once both supply voltages are within tolerance, **HEALTHY#** will pull low and **LOCAL\_PCI\_RST#** is free to follow **PCI\_RST#**.

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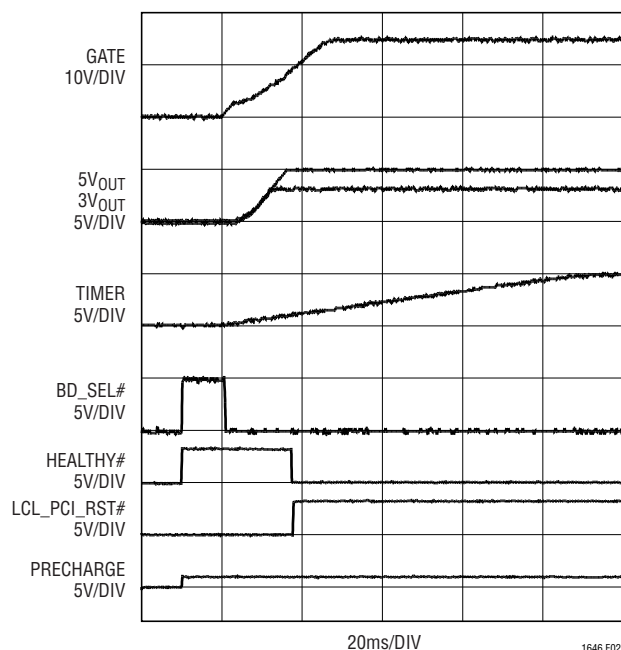


Figure 2. Normal Power-Up Sequence

## Power-Down Sequence

When BD\_SEL# is pulled high, a power-down sequence begins (Figure 3).

Internal switches are connected to each of the output supply voltage pins to discharge the bypass capacitors to ground. The TIMER pin (Pin 2) is immediately pulled low. The GATE pin (Pin 10) is pulled down by a 200μA current source to prevent the load currents on the 3.3V and 5V supplies from going to zero instantaneously in order to prevent glitching the power supply voltages. When either of the output voltages dips below its threshold, HEALTHY# pulls high and LOCAL\_PCI\_RST# will be asserted low.

Once the power-down sequence is complete, the CPCI card may be removed from the slot. During extraction, the precharge circuit will continue to bias the bus I/O pins at 1V until the 5V and 3.3V long connector pin connections are separated.

## Timer

During a power-up sequence, a 5μA current source is connected to the TIMER pin and current limit faults are ignored until the voltage exceeds 1.25V. This feature

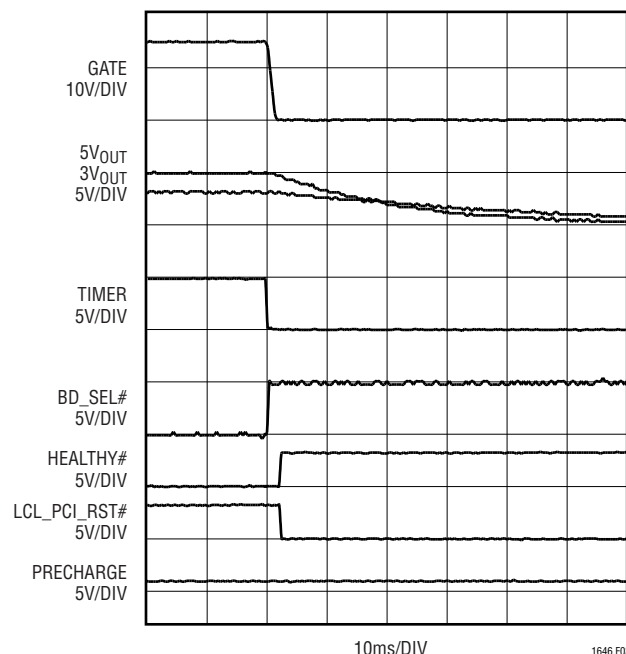


Figure 3. Normal Power-Down Sequence

allows the chip to power up CPCI boards with widely varying capacitive loads on the supplies. The power-up time for either of the two outputs is given by:

$$t_{ON}(XV_{OUT}) = 2 \cdot \frac{C_{LOAD}(XV_{OUT}) \cdot XV_{OUT}}{I_{LIMIT}(XV_{OUT}) - I_{LOAD}(XV_{OUT})} \quad (2)$$

Where  $XV_{OUT} = 5V_{OUT}$  or  $3V_{OUT}$ . For example, for  $C_{LOAD}(5V_{OUT}) = 2000\mu F$ ,  $I_{LIMIT} = 7A$ , and  $I_{LOAD} = 5A$ , the  $5V_{OUT}$  turn-on time will be ~10ms. By substituting the variables in Equation 2 with the appropriate values, the turn-on time for the  $3V_{OUT}$  output can also be calculated. The timer period should be set longer than the maximum supply turn-on time but short enough to not exceed the maximum safe operating area of the pass transistor during a short-circuit. The timer period for the LTC1646 is given by:

$$t_{TIMER} = \frac{C_{TIMER} \cdot 1.25V}{5\mu A} \quad (3)$$

As a design aid, the timer period as a function of the timing capacitor using standard values from 0.01μF to 1μF is shown in Table 2.

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Table 2.  $t_{\text{TIMER}}$  vs  $C_{\text{TIMER}}$ 

$C_{\text{TIMER}}$	$t_{\text{TIMER}}$	$C_{\text{TIMER}}$	$t_{\text{TIMER}}$
0.01 $\mu\text{F}$	2.5ms	0.22 $\mu\text{F}$	55ms
0.022 $\mu\text{F}$	5.5ms	0.33 $\mu\text{F}$	82.5ms
0.033 $\mu\text{F}$	8.25ms	0.47 $\mu\text{F}$	118ms
0.047 $\mu\text{F}$	11.8ms	0.68 $\mu\text{F}$	170ms
0.068 $\mu\text{F}$	17ms	0.82 $\mu\text{F}$	205ms
0.082 $\mu\text{F}$	20.5ms	1 $\mu\text{F}$	250ms
0.1 $\mu\text{F}$	25ms		

The TIMER pin is immediately pulled low when  $\text{BD\_SEL\#}$  goes high.

## Short-Circuit Protection

During a normal power-up sequence, if the TIMER pin is done ramping and a supply is still in current limit, all of the pass transistors will be immediately turned off and  $\overline{\text{FAULT}}$  (Pin 3) will be pulled low as shown in Figure 4.

In order to prevent excessive power dissipation in the pass transistors and to prevent voltage spikes on the supplies during short-circuit conditions, the current limit on each supply is designed to be a function of the output voltage. As the output voltage drops, the current limit decreases.

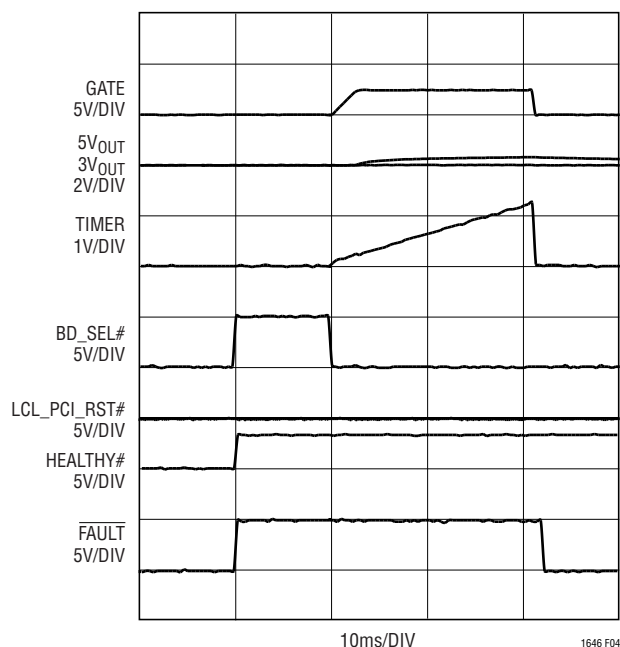


Figure 4. Power-Up into a Short on 3.3V Output

Unlike a traditional circuit breaker function where huge currents can flow before the breaker trips, the current foldback feature assures that the supply current will be kept at a safe level and prevents voltage glitches at the input supply when powering up into a short circuit.

After power-up (TIMER pin voltage  $>1.25\text{V}$ ), the 5V and 3.3V supplies are protected from overcurrent and short-circuit conditions by dual-level circuit breakers. If the sense resistor voltage of either supply current exceeds 56mV but is less than 150mV, an internal timer is started. If the supply is still overcurrent after 21 $\mu\text{s}$ , the circuit breaker trips and both supplies are turned off (Figure 5).

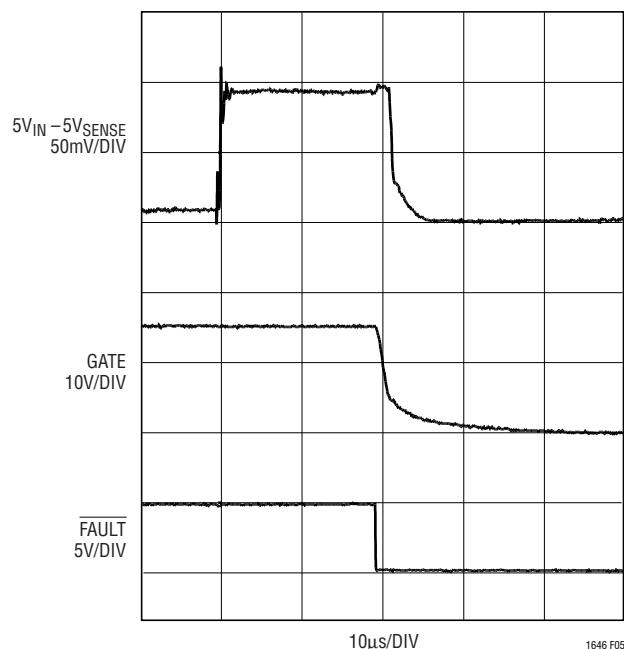


Figure 5. Overcurrent Fault on 5V

If a short-circuit occurs and the sense resistor voltage of either supply current exceeds 150mV, the circuit breakers trip without delay and the chip latches off (Figure 6). The chip will stay in the latched-off state until  $\text{OFF/ON}$  (Pin 15) is cycled high then low, or the  $5\text{V}_{\text{IN}}$  (Pin 12) power supply is cycled.

The current limit and the foldback current level for the 5V and 3.3V outputs are both a function of the external sense resistor ( $R_1$  for  $3\text{V}_{\text{OUT}}$  and  $R_2$  for  $5\text{V}_{\text{OUT}}$ , see Figure 1). As shown in Figure 1, a sense resistor is connected between

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$$I_{LIMIT(XVOUT)} = \frac{55mV}{R_{SENSE(XVOUT)}} \quad (4)$$

$$I_{\text{FOLDBACK}(XVOUT)} = \frac{20\text{mV}}{R_{\text{SENSE}(XVOUT)}} \quad (5)$$

### Table 3. I<sub>LIMIT(XVOUT)</sub> and I<sub>FOLDBACK(XVOUT)</sub> vs R<sub>SENSE</sub>

where  $XV_{OUT} = 3V_{OUT}$  or  $5V_{OUT}$ .

**Figure 7. Circuit Breaker Equivalent Circuit for Calculating  $R_{SENSE}$**

$$R_{\text{SENSE(MAX)}} = \frac{V_{\text{CB(MIN)}}}{I_{\text{TRIP(MAX)}}} \quad (6)$$

The second step is to determine the nominal value of the sense resistor which is dependent on its tolerance

## APPLICATIONS INFORMATION

(RTOL =  $\pm 1\%$ ,  $\pm 2\%$  or  $\pm 5\%$ ) and standard sense resistor values. Equation 7 can be used to calculate the nominal value from the maximum value found by Equation 6:

$$R_{\text{SENSE(NOM)}} = \frac{R_{\text{SENSE(MAX)}}}{1 + \left(\frac{\text{RTOL}}{100}\right)} \quad (7)$$

Often, the result of Equation 7 may not yield a standard sense resistor value. In this case, two sense resistors with the same RTOL can be connected in parallel to yield  $R_{\text{SENSE(NOM)}}$ .

The last step requires calculating a new value for  $I_{\text{TRIP(MAX, NEW)}}$  based on a minimum value for  $R_{\text{SENSE}}$  ( $R_{\text{SENSE(MIN)}}$ ) and the upper limit for the circuit breaker threshold,  $V_{\text{CB(MAX)}}$ . Should the calculated value for  $I_{\text{TRIP(MAX, NEW)}}$  be much greater than the design value for  $I_{\text{TRIP(MAX)}}$ , a larger sense resistor value should be selected and the process repeated. The new value for  $I_{\text{TRIP(MAX, NEW)}}$  is given by Equation 8:

$$I_{\text{TRIP(MAX, NEW)}} = \frac{V_{\text{CB(MAX)}}}{R_{\text{SENSE(MIN)}}} \quad (8)$$

$$\text{where } R_{\text{SENSE(MIN)}} = R_{\text{SENSE(NOM)}} \cdot \left[1 - \left(\frac{\text{RTOL}}{100}\right)\right]$$

*Example:* A 5V supply exhibits a nominal 5A load with a maximum load current of 6.8A ( $I_{\text{LOAD(MAX)}} = 6.8\text{A}$ ), and sense resistors with  $\pm 5\%$  RTOL will be used. According to Equation 6,  $V_{\text{CB(MIN)}} = 50\text{mV}$  and  $R_{\text{SENSE(MAX)}}$  is given by:

$$R_{\text{SENSE(MAX)}} = \frac{V_{\text{CB(MIN)}}}{I_{\text{TRIP(MAX)}}} = \frac{50\text{mV}}{6.8\text{A}} = 0.0074\Omega$$

The nominal sense resistor value is (Equation 7):

$$R_{\text{SENSE(NOM)}} = \frac{R_{\text{SENSE(MAX)}}}{1 + \left(\frac{\text{RTOL}}{100}\right)} = \frac{0.0074\Omega}{1 + \left(\frac{5}{100}\right)} = 0.007\Omega$$

And the new current-limit trip point is Equation 8:

$$I_{\text{TRIP(MAX, NEW)}} = \frac{V_{\text{CB(MAX)}}}{R_{\text{SENSE(MIN)}}} = \frac{V_{\text{CB(MAX)}}}{R_{\text{SENSE(NOM)}} \cdot \left[1 - \left(\frac{\text{RTOL}}{100}\right)\right]} = \frac{65\text{mV}}{0.0065} = 9.8\text{A}$$

Since  $I_{\text{TRIP(MAX, NEW)}} > I_{\text{LOAD(MAX)}}$ , a larger value for  $R_{\text{SENSE}}$  should be selected and the process repeated again to lower  $I_{\text{TRIP(MAX, NEW)}}$  without substantially affecting  $I_{\text{LOAD(MAX)}}$ .

### Output Voltage Monitor

The status of both 5V and 3.3V output voltages is monitored by the power good function. In addition, the PCI\_RST# signal is logically combined on-chip with the HEALTHY# signal to create LOCAL\_PCI\_RST# (see Table 4).

**Table 4. LOCAL\_PCI\_RST# Truth Table**

PCI_RST#	HEALTHY#	LOCAL_PCI_RST#
LO	LO	LO
LO	HI	LO
HI	LO	HI
HI	HI	LO

If either of the output voltages drop below the power good threshold for more than 50 $\mu\text{s}$ , the HEALTHY# signal will be pulled high and the LOCAL\_PCI\_RST# signal will be pulled low.

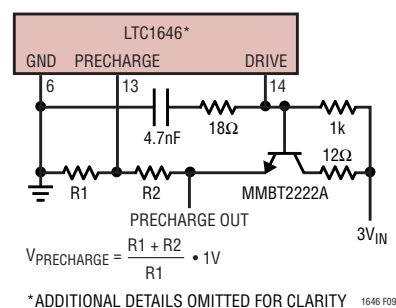
### Precharge

The PRECHARGE input and DRIVE output pins are intended for use in generating the 1V precharge voltage that is used to bias the bus I/O connector pins during board insertion. The LTC1646 is also capable of generating precharge voltages other than 1V. Figure 8 shows a circuit that can be used in applications requiring a precharge voltage less than 1V. The circuit in Figure 9 can be used for applications that need precharge voltages greater than 1V. Table 5 lists suggested resistor values for R1 and R2 vs precharge voltage for the application circuits shown in Figures 8 and 9.

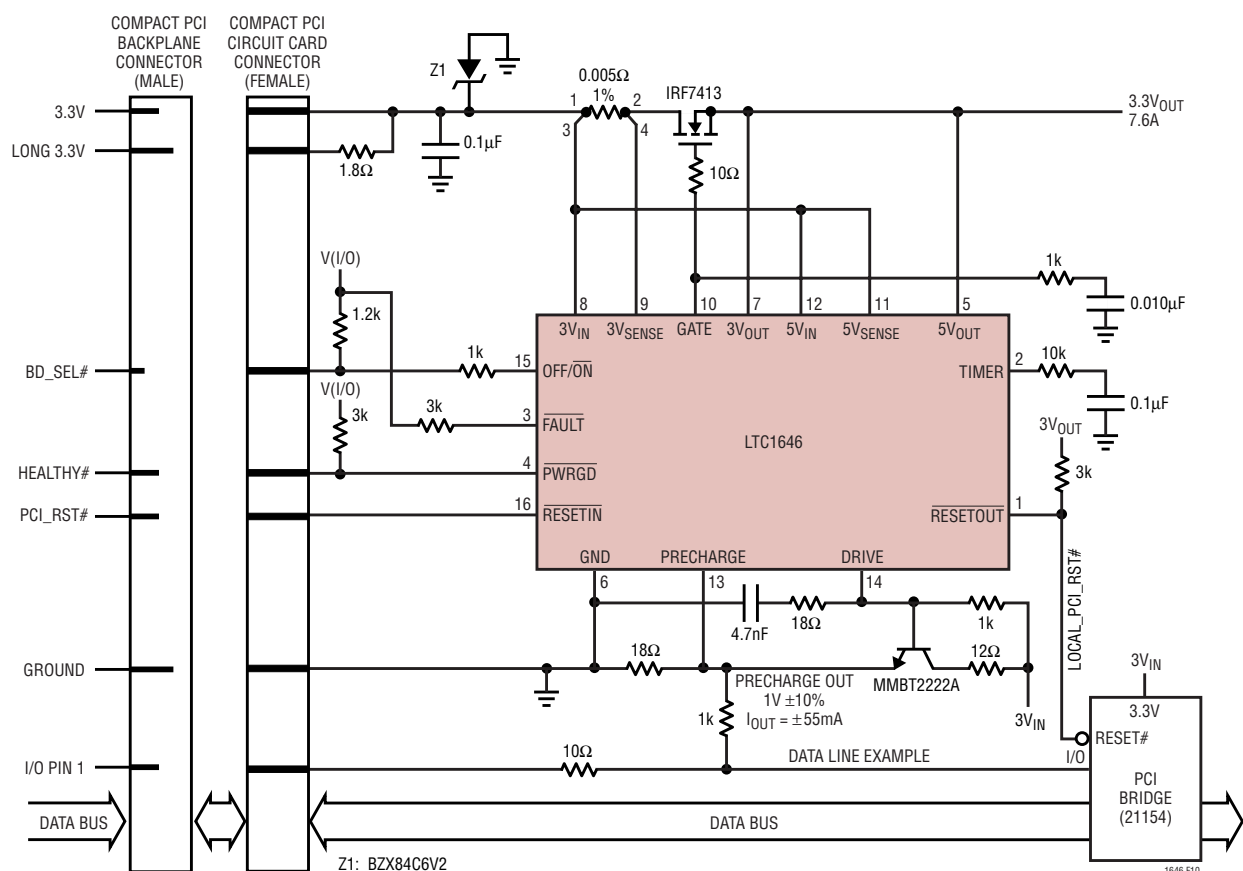


$V_{PRECHARGE}$	R1	R2	$V_{PRECHARGE}$	R1	R2
1.5V	18Ω	9.09Ω	0.9V	16.2Ω	1.78Ω
1.4V	18Ω	7.15Ω	0.8V	14.7Ω	3.65Ω
1.3V	18Ω	5.36Ω	0.7V	12.1Ω	5.11Ω
1.2V	18Ω	3.65Ω	0.6V	11Ω	7.15Ω
1.1V	18Ω	1.78Ω	0.5V	9.09Ω	9.09Ω
1V	18Ω	0Ω			

The LTC1646 can be easily configured for applications where no 5V supply is present by simply tying the 5V<sub>IN</sub> and 5V<sub>SENSE</sub> pins to the 3V<sub>IN</sub> pin and tying the 5V<sub>OUT</sub> pin to the 3V<sub>OUT</sub> pin (Figure 10).

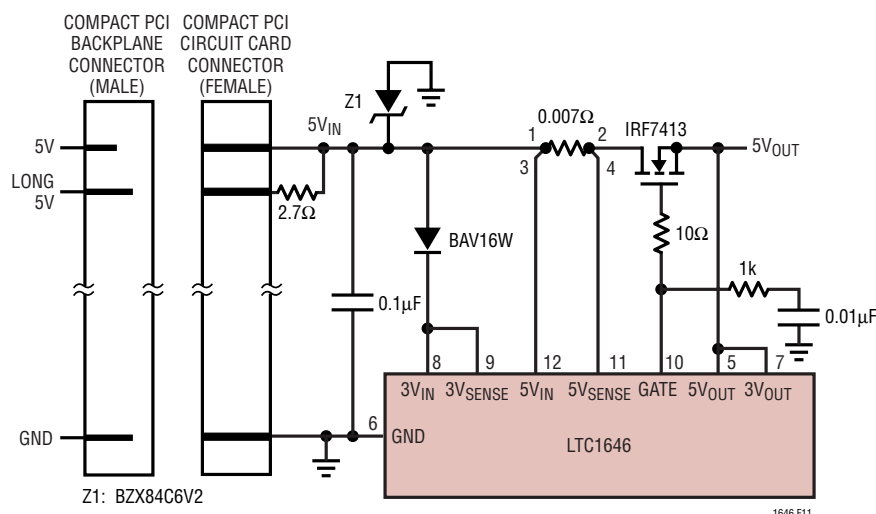


### Figure 9. Precharge Voltage >1V Application Circuit



### Figure 10. 3.3V Supply Only Typical Application

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### Figure 11. 5V Supply Only Typical Application

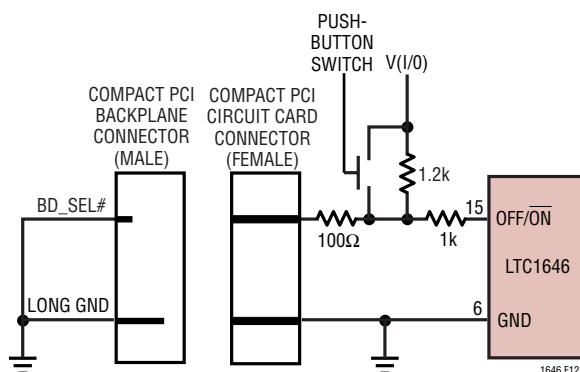
If no 3.3V supply is present, Figure 11 illustrates how the LTC1646 should be configured. First,  $3V_{SENSE}$  (Pin 9) is connected to  $3V_{IN}$  (Pin 8),  $3V_{OUT}$  (Pin 7) is connected to  $5V_{OUT}$  (Pin 5) and the LTC1646's  $3V_{IN}$  pin is connected through a diode (BAV16W) to  $5V_{IN}$ .

For applications where the BD\_SEL# connector pin is typically grounded on the backplane, the circuit in Figure 12 allows the LTC1646 to be reset simply by pressing a pushbutton switch on the CPCI plug-in board. This arrangement eliminates the requirement to extract and reinsert the CPCI board in order to reset the LTC1646's circuit breakers.

## Overvoltage Transient Protection

Good engineering practice calls for bypassing the supply rail of any analog circuit. Bypass capacitors are often placed at the supply connection of every active device, in addition to one or more large-value bulk bypass capacitors per supply rail. If power is connected abruptly, the large bypass capacitors slow the rate of rise of the supply voltage and heavily damp any parasitic resonance of lead or PC trace inductance working against the supply bypass capacitors.

The opposite is true for LTC1646 Hot Swap circuits mounted on plug-in cards. In most cases, there is no supply bypass capacitor present on the powered 3.3V or 5V side of the MOSFET switch. An abrupt connection, produced by inserting the board into a backplane connector, results in a fast rising edge applied on the 3.3V and the 5V line of the LTC1646.



**Figure 12. BD SEL# Pushbutton Toggle Switch**

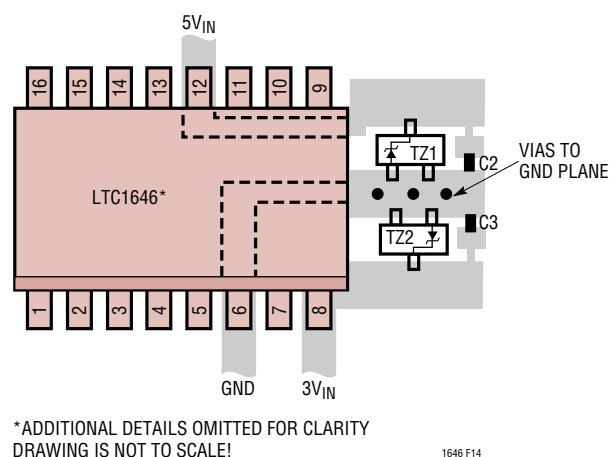


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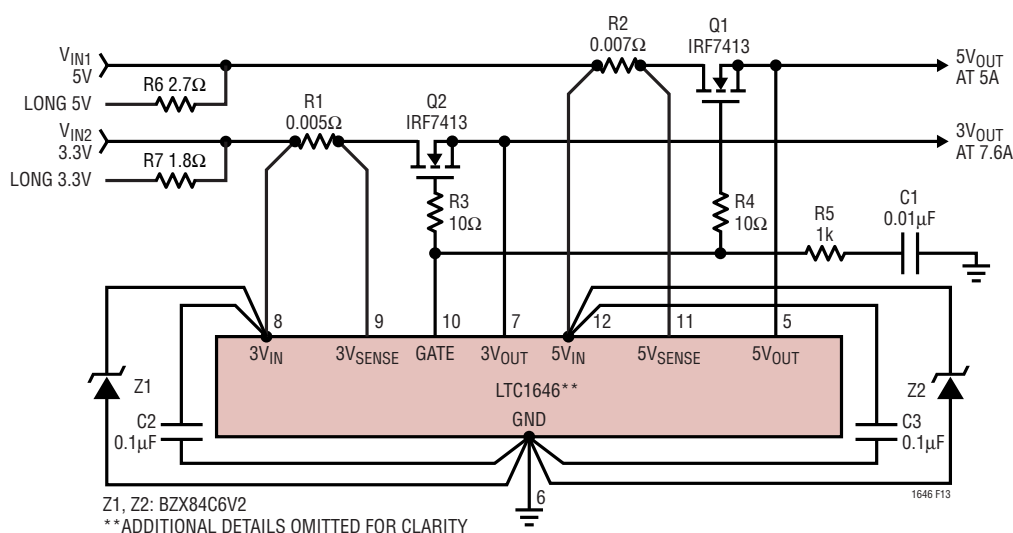
Since there is no bulk capacitance to damp the parasitic trace inductance, supply voltage transients excite parasitic resonant circuits formed by the power MOSFET capacitance and the combined parasitic inductance from the wiring harness, the backplane and the circuit board traces. These ringing transients appear as a fast edge on the 3.3V or 5V supply, exhibiting a peak overshoot to 2.5 times the steady-state value followed by a damped sinusoidal response whose duration and period is dependent on the resonant circuit parameters. Since the absolute maximum supply voltage of the LTC1646 is 10V, transient protection against 3.3V and 5V supply voltage spikes and ringing is highly recommended.

In these applications, there are two methods for eliminating these supply voltage transients: using Zener diodes to clip the transient to a safe level and snubber networks. Snubbers are RC networks whose time constants are large enough to safely damp the inductance of the board's parasitic resonant circuits. As a starting point, the shunt capacitors in these networks are chosen to be  $10\times$  to  $100\times$  the power MOSFET's  $C_{OSS}$  under bias. The value of the series resistor (R6 and R7 in Figure 13) is then chosen to be large enough to damp the resulting series R-L-C circuit and typically ranges from  $1\Omega$  to  $10\Omega$ . Note that in all

LTC1646 circuit schematics, Zener diodes and snubber networks have been added to each 3.3V and 5V supply rail and should be used always. These protection networks should be mounted very close to the LTC1646's supply voltage using short lead lengths to minimize lead inductance. This is shown schematically in Figure 13 and a recommended layout of the transient protection devices around the LTC1646 is shown in Figure 14.



**Figure 14. Recommended Layout for Transient Protection Components**



**Figure 13. Place Transient Protection Device Close to the LTC1646**

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### PCB Layout Considerations

For proper operation of the LTC1646's circuit breaker function, a 4-wire Kelvin connection to the sense resistors is highly recommended. A recommended PCB layout for the sense resistor, the power MOSFET, and the GATE drive components around the LTC1646 is illustrated in Figure 15. In Hot Swap applications where load currents can reach 10A, narrow PCB tracks exhibit more resistance than wider tracks and operate at more elevated temperatures. Since the sheet resistance of 1 ounce copper foil is approximately  $0.5\text{m}\Omega/\square$ , track resistances add up quickly in high current applications. Thus, to keep PCB track resistance and temperature rise to a minimum, the suggested trace width in these applications for 1 ounce copper foil is 0.03" for each ampere of DC current.

In the majority of applications, it will be necessary to use plated-through vias to make circuit connections from component layers to power and ground layers internal to the PC board. For 1 ounce copper foil plating, a general rule is 1A of DC current per via, making sure the via is properly dimensioned so that solder completely fills any void. For other plating thicknesses, check with your PCB fabrication facility.

### Power MOSFET and Sense Resistor Selection

Table 6 lists some current MOSFET transistors that are available and Table 7 lists some current sense resistors that can be used with the LTC1646's circuit breakers. Table 8 lists supplier web site addresses for discrete component mentioned throughout the LTC1646 data sheet.

**Table 6. N-Channel Power MOSFET Selection Guide**

CURRENT LEVEL (A)	PART NUMBER	DESCRIPTION	MANUFACTURER
0 to 2	MMDF3N02HD	Dual N-Channel SO-8 $R_{DS(ON)} = 0.1\Omega$	ON Semiconductor
2 to 5	MMSF5N02HD	Single N-Channel SO-8 $R_{DS(ON)} = 0.025\Omega$	ON Semiconductor
5 to 10	MTB50N06V	Single N-Channel DD Pak $R_{DS(ON)} = 0.028\Omega$	ON Semiconductor
5 to 10	IRF7413	Single N-Channel SO-8 $R_{DS(ON)} = 0.01\Omega$	International Rectifier
5 to 10	Si4410DY	Single N-Channel SO-8 $R_{DS(ON)} = 0.01\Omega$	Vishay-Siliconix

**Table 7. Sense Resistor Selection Guide**

CURRENT LIMIT VALUE	PART NUMBER	DESCRIPTION	MANUFACTURER
1A	LR120601R055F WSL1206R055	0.055 $\Omega$ , 0.5W, 1% Resistor	IRC-TT Vishay-Dale
2A	LR120601R028F WSL1206R028	0.028 $\Omega$ , 0.5W, 1% Resistor	IRC-TT Vishay-Dale
5A	LR120601R011F WSL2010R011	0.011 $\Omega$ , 0.5W, 1% Resistor	IRC-TT Vishay-Dale
7.6A	WSL2512R007	0.007 $\Omega$ , 1W, 1% Resistor	Vishay-Dale
10A	WSL2512R005	0.005 $\Omega$ , 1W, 1% Resistor	Vishay-Dale

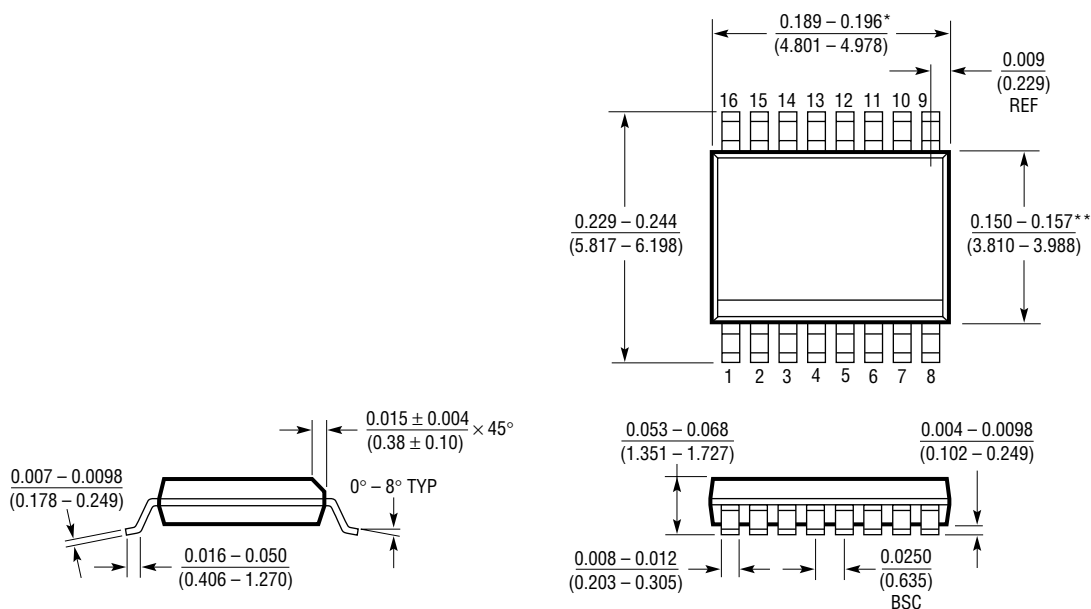
## APPLICATIONS INFORMATION

**Table 8. Manufacturers' Web Site**

MANUFACTURER	WEB SITE
International Rectifier	<a href="http://www.irf.com">www.irf.com</a>
ON Semiconductor	<a href="http://www.onsemi.com">www.onsemi.com</a>
IRC-TT	<a href="http://www.irctt.com">www.irctt.com</a>
Vishay-Dale	<a href="http://www.vishay.com">www.vishay.com</a>
Vishay-Siliconix	<a href="http://www.vishay.com">www.vishay.com</a>
Diodes, Inc.	<a href="http://www.diodes.com">www.diodes.com</a>

## PACKAGE DESCRIPTION

### GN Package 16-Lead Plastic SSOP (Narrow .150 Inch) (Reference LTC DWG # 05-08-1641)



\* DIMENSION DOES NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.006" (0.152mm) PER SIDE

\*\* DIMENSION DOES NOT INCLUDE INTERLEAD FLASH. INTERLEAD FLASH SHALL NOT EXCEED 0.010" (0.254mm) PER SIDE

GN16 (SSOP) 1098

